



Calling for papers/ abstracts/ speakers/ TPC member

Session Description

2019 5th International Conference on Mechanical Structures and Smart Materials (5th ICMSSM2019) is being organized and will be held on **27-28, May, 2019 in Xi'an, China**. The ICMSSM 2019 is co-sponsored by Trans Tech publications & X-academy. All accepted paper will be published in **Materials Science Forum** [ISSN print 0255-5476 ISSN cd 1662-9760 ISSN web 1662-9752, Trans Tech Publications]. And the press will submit all papers to major databases such as **El Compendex, Scopus and Scholar**.

Important Dates

Submission Deadline: May 31, 2019 (The third round)

Acceptance Notification: June 7, 2019

Registration Due: June 14, 2019

Conference Dates: May 27-28, 2019

Topics (not limited to)

T1: Material Science and Engineering

T2: Materials Processing Technology

T3: Material Science and Technology

Submission Ways

1. Email: cfp@icmssm.org
2. Submit by CMT system: <https://cmt3.research.microsoft.com/ICMSSM2019>

Note: The conference's official language is English. All papers must be written in English and must be formatted MS Word according to the following instructions. In addition, all papers should be no less than 6 pages in length and must be written in strict accordance with the format. Shorter papers should not be included in the journal.

Contact us

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